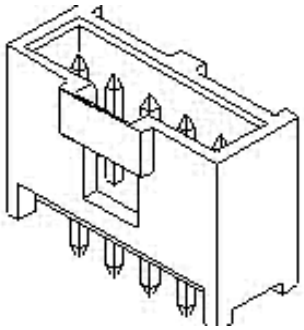
molex



Part Number : 901361112
Product Description : C-Grid III Header, Single Row, Vertical, Shrouded, 12 Circuits, 4µm Tin/Lead (Sn) over Nickel (Ni)
Series Number : 90136
Status : Active
Product Category : PCB Headers and Receptacles

Documents & Resources

Drawings

901361112_sd.pdf

PK-90136-001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

901190001-AS-000.pdf

PS-99020-0001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90136
Description	C-Grid III Header, Single Row, Vertical, Shrouded, 12 Circuits, 4µm Tin/Lead (Sn) over Nickel (Ni)
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid III
UPC	800753676558

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V AC/DC

Physical

Breakaway	No
Circuits (Loaded)	12
Circuits (maximum)	12
Color - Resin	Black
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	1.753/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.90mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	3.048µm
Plating min - Termination	3.048µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	WAVE

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Modular Single Row Crimp Housings	90123
C-Grid III Single Row Crimp Housings	90156